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## AMENDMENT TO THE CLAIMS

1-29 (canceled)

- 30. (Original) A method of operating a semiconductor process including processing of or with a gas, said method comprising sensing concentration of a desired component of said gas with a thermopile detector, generating an output from said thermopile detector indicative of concentration of said selected component of said gas, and controlling one or more conditions in and/or affecting the semiconductor process, in response to said output.
- 31. (Original) The method of claim 30, wherein the one or more conditions in and/or affecting the process include flow rate of a chemical reagent to a semiconductor process tool,
- 32. (Original) The method of claim 30, wherein the one or more conditions in and/or affecting the process include flow rate of a gas stream discharged from or flowed to a process unit in the semiconductor process.
- 33. (Original) The method of claim 32, wherein the gas stream to a semiconductor process tool is monitored.

- 34. (Original) The method of claim 32, wherein the gas stream flowed to an abatement unit is monitored.
- 35. (Original) The method of claim 32, wherein the gas stream discharged by an abatement unit is monitored.
- 36. (Original) The method of claim 30, wherein the thermopile sensor output is employed to modulate a valve.
- 37. (Original) The method of claim 30, wherein the thermopile detector output is employed to modulate a set point of a mass flow controller.
- 38. (Original) The method of claim 30, wherein the thermopile detector output is employed to modulate flow of a scrubbing medium in an abatement treatment step of the process.
- 39. (Original) The method of claim 30, wherein the thermopile detector output is employed to terminate a first process step and initiate a second process step.
- 40. (Original) The method of claim 30, wherein the thermopile detector output is employed to modulate recycle of a fluid stream in the process.
- 41. (New) A method of operating a semiconductor process including processing of or with a material, said method comprising sensing concentration of a desired component of said material with a thermopile detector, generating an output from

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said thermopile indicative of concentration of said selected component of said material, and controlling one or more conditions in and/or affecting the semiconductor process, in response to said output.

- 42. (New) The method of claim 41, wherein the material comprises a solid.
- 43. (New) The method of claim 41, wherein the material comprises a fluid.
- 44. (New) The method of claim 41, wherein the material comprises a liquid.
- 45. (New) The method of claim 41, wherein the material comprises a gas.